

190115457 Cut Tape Packing Method Standardization for Modules with non-Reel **Packing**

Bulletin Issue Date: Effective Date: 1/15/2019 1/15/2019

Description of Change

Silicon Labs is announcing standardization of the packing method for modules shipped in non-reel packing. The Cut Tape packing method will be used for modules in sealed carrier tape pockets without leader and trailer empty pockets.

Reason for Change

To standardize Cut Tape packing method for all Silicon Labs modules with non-reel part number.

Product Identification

Existing Part # ABM1XX ABM2XX ABM3XX **AMSØXX AMW0XX** AMW1XX BGM1XX BGM2XX BLE1XX BT1XX ETRX357X ETRX358X MGM1XX MGM2XX WF11X WF12X WT11X WT12X WT32X **WT41X** ZM3XX ZM5XX Where 'XX' represents additional orderable part numbers that begin with the same prefix.

This change is considered a minor change which does not affect form, fit, function, quality, or reliability. The information is being provided as a customer courtesy.

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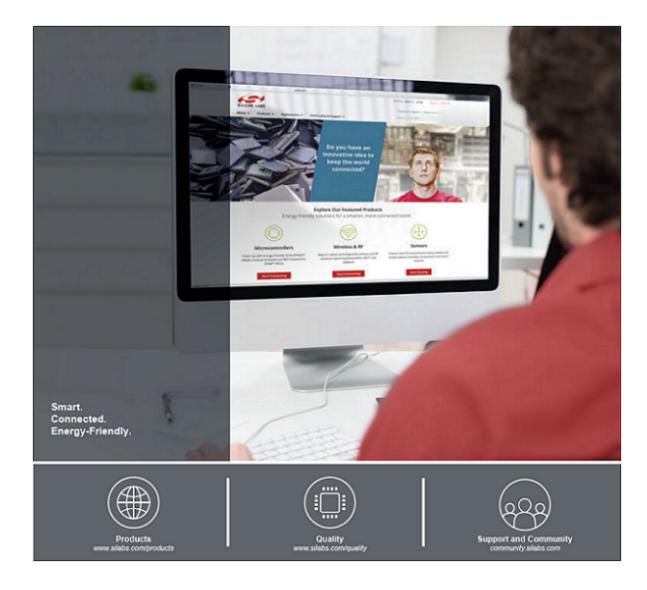
Customer Actions Needed:

No action is needed from customers

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Cut tape - Sample Photo



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